



SCHUNK-DC

SCHUNK-RDC

MICRO-GRID 13/12TH CPU FANLESS

COMPUTER COMPUTER



MICRO-GRID COMPUTER

- Intel® 12th / 13th Gen Alder Lake-S / Raptor Lake-S Core™ i9/i7/i5/i3 up to TDP 65W
- Up to 64G DDR4 SO-DIMM 3200 MHz
- 2 x DP, 2 x LAN, 6x USB
- 2x 2.5" Easy swap SSD Tray
- 2 x PCIe Gen4 x 8 slot
- DC-IN 9~36V (Support Redundant)
- Operation Temp. -20°C to 60°C

Specifications

SYSTEM

CPU	13th/12th Gen Intel® Raptor Lake-S/Alder Lake-S LGA1700 Socket Processor / Core i9/i7/i5/i3 Processor up to TDP 65W
Memory Capacity	DDR4 SO-DIMM 3200 MHz up to 64G
Chipset	Q670

DISPLAY

GPU	Intel® UHD Graphics
Display Port	DisplayPort 1.4, DP++ Max resolution up to 4k (4096x2304@60Hz)
2 nd Display Port	DisplayPort 1.4, DP++ Max resolution up to 4k (4096x2304@60Hz)

EXPANSION

PCIe Slot	2 x PCIe Gen4 x 8 Slot
M.2	1x M.2 2280M-key (PCIe Gen 3.0 X 4, SATAIII)

STORAGE

SATA	Up to 4TB SATAIII
M.2	Up to 2TB NVMe & SATAIII

ETHERNET

Ethernet	Intel® I219-LM Giga LAN
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FRONT I/O

Power Button	1 x Power Button
Indicator	1 x HDD backlight / 1 x Power backlight
USB3.0	2 x USB 3.0

REAR I/O

Power Input	1 x 4P Terminal Block 9~36V DC-IN (2 x 4P Terminal Block 9~36V DC-IN with Redundant)
LAN	2 x 1GbE RJ45
USB3.2	2 x USB 3.2
USB2.0	2 x USB2.0
DisplayPort	2 x DP
Storage	2 x 2.5" Swap SSD Tray

POWER REQUIREMEN

Power Input DC-IN 9~36V (With Redundant)

OS SUPPORT LIST

OS Windows® 11 64bit, / Windows® 10 IoT LTSC 64bit (LTSC 2021) /Ubuntu 22.04 / Linux (support by request)

MECHANICAL AND ENVIRONMENTAL

Dimension 220 x 315 x167 mm (W x D x H)

Operating Temp. -20°C to 60°C

Storage Temp. -40°C to 85°C

Relative Humidity 5% to 95%, non-condensing

System Design Fanless

CERTIFICATION

IEC-61850-3 / IEEE-1613 / UL 62368-1 / EN60945 / CE / FCC

Ordering Information

SCX3X2-DC

Micro-Gird Fanless Computer with Intel 13th /12th Gen Intel® Raptor Lake-S/Alder Lake-S LGA1700 Socket Processor / Core i9/i7/i5/i3 Processor TDP 65W, up to 64G SO-DIMM DDR4 3200MHz, 2 × 1GbE, 2 x USB3.2, 2 x USB3.0, 2 x USB2.0, 2 x DP, 2 x 2.5" SwapSSD Tray, DC-IN 9~36V , Operating Temperature -20°C~+60°C

SCX3X2-RDC

Micro-Gird Fanless Computer with Intel 13th /12th Gen Intel® Raptor Lake-S/Alder Lake-S LGA1700 Socket Processor / Core i9/i7/i5/i3 Processor / TDP 65W, up to 64G SO-DIMM DDR4 3200MHz, 2 × 1GbE RJ45, 2 x USB3.2, 2 x USB3.0, 2 x USB2.0, 2 x DP, 2 x 2.5" SwapSSD Tray, DC-IN 9~36V with redundant, Operating Temperature -20°C~+60°C

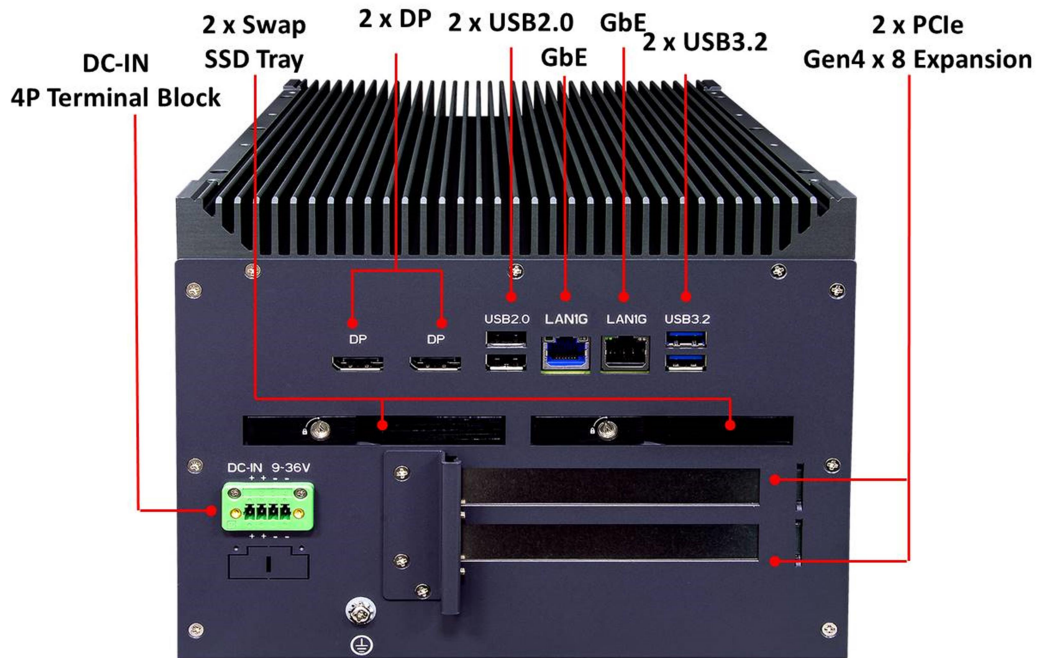
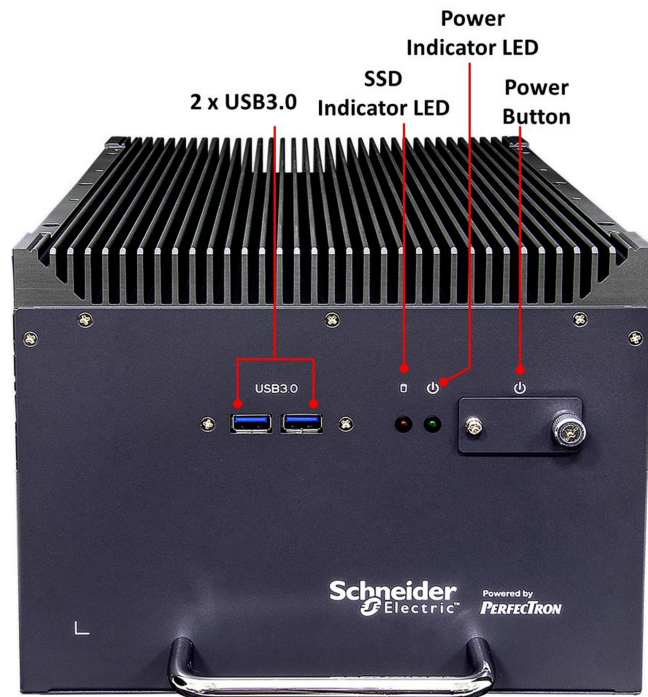
	SCH3X2-DC	SCH3X2-RDC
CPU	12/13th Gen Intel® Core i9/i7/i5/i3 Processor TDP 65W	
RAM	Up to 64GB SO_DIMM, DDR4-3200MHz	
Expansion	2 x PCIe Gen4 x 8 1 x M.2 2280(Gen3 x 4,SATAIII)	
Storage	Up to 4TB SATAIII Up to 2TB NVMe & SATAIII	
I/O	2 × RJ45, 6 x USB, 2 x DP, 2 x 2.5" SwapTray	
Power	DC-IN 9~36V	DC-IN 9~36V W/Redundant
Operation Temp.	-20°C~+60°C	

Accessories Kit (Option)

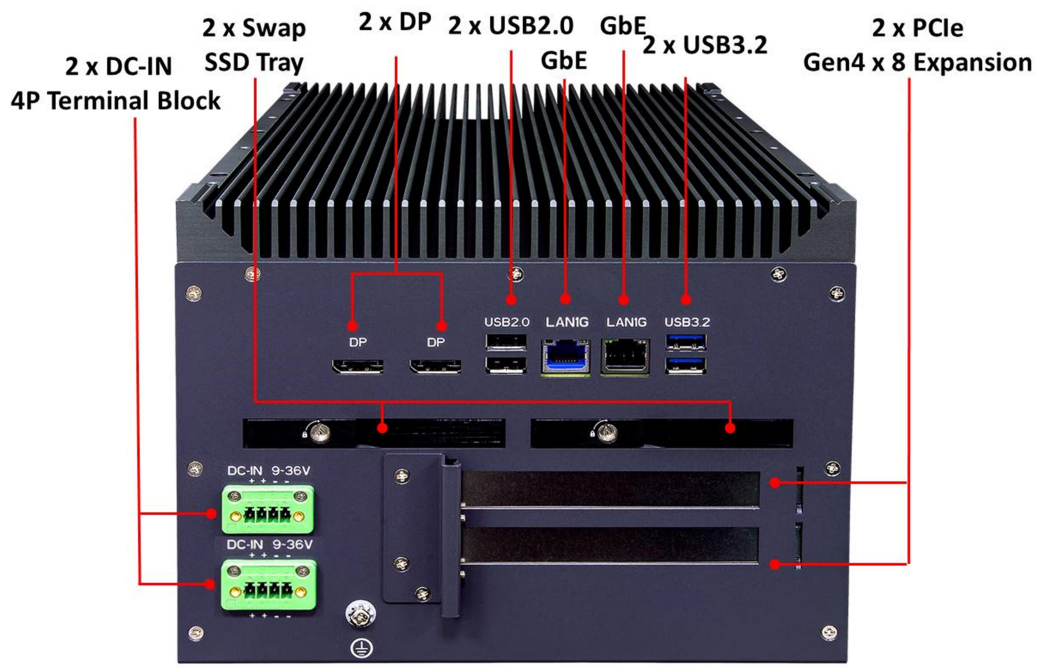
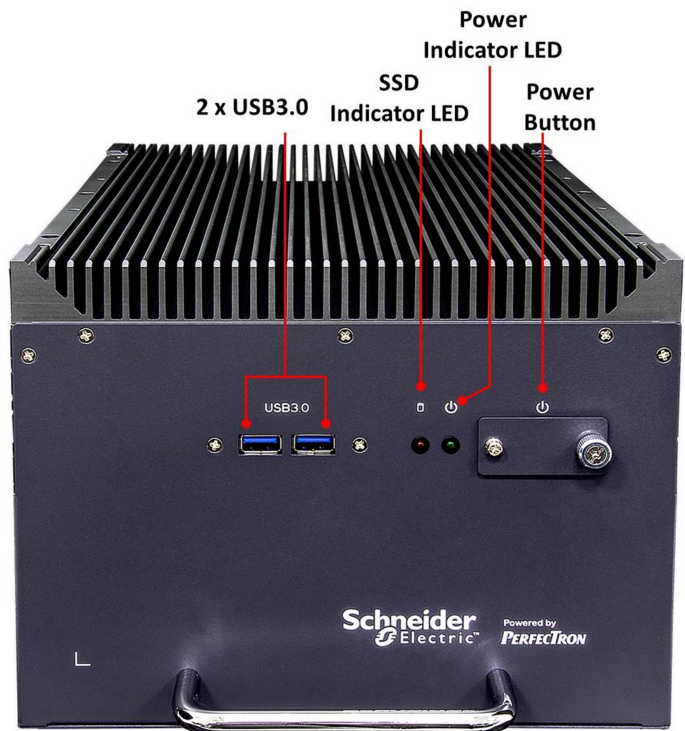
P/N	Description	Q'ty
0ZAKSCH3X2000000	Accessories Kit for SCH3X2/SCH4X2 Dual Machine Rackmount Bracket	1
0ZAKSCH3X2000001	Accessories Kit for SCH3X2/SCH4X2 Single Machine Rackmount Bracket	1

Appearance

SCH3X2-DC :

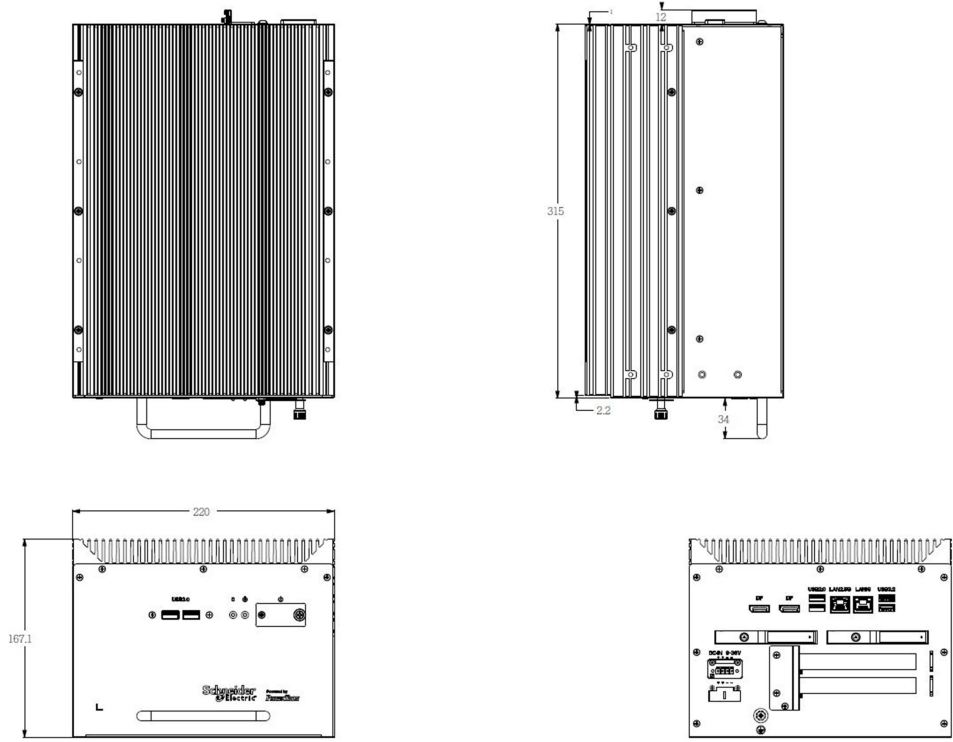


SCH3X2-RDC :



Drawing and Dimension

SCH3X2-DC :



SCH3X2-RDC :

